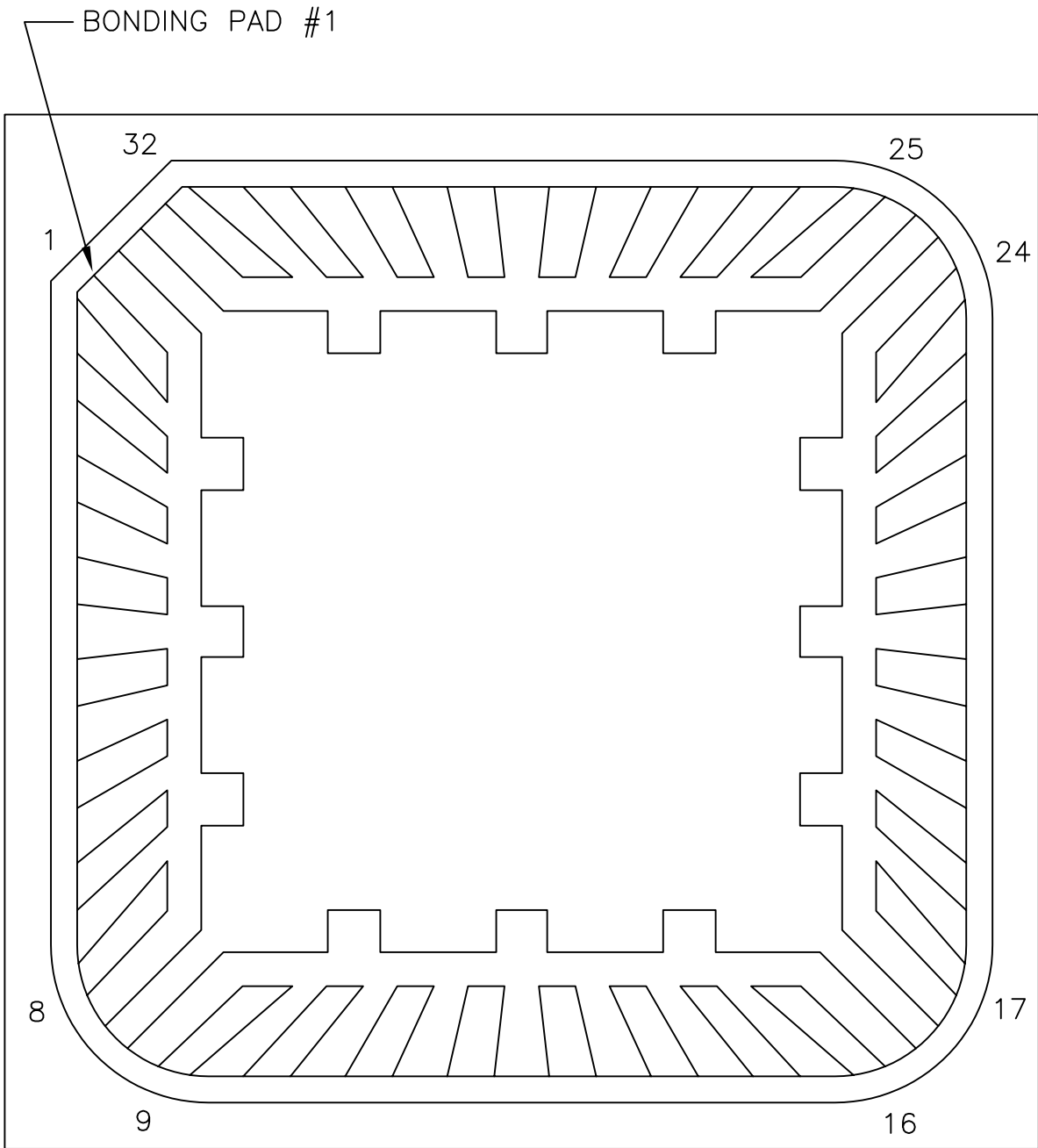


SEMPAC REVISIONS			
ECN NO.	DATE	DESCRIPTION	APPROVED
10761	10/12/06	PRODUCTION RELEASE	D. MORRIS
DRAWN BY	C. CRUZ	DATE	10/12/06
APP BY	BYF.FLASKERUD	DATE	10/12/06



DEVICE TYPE:		SEMPAC, INC. Open-Pak™ Technologies www.sempac.com 568 E. WEDDELL DRIVE, SUITE 5 SUNNYVALE, CALIFORNIA 94089 PHONE: (408) 400-9002 FAX: (408) 400-9006		
CUSTOMER:				
WIRE TYPE/ SIZE:				
THIRD ANGLE PROJECTION	PACKAGE SIZE: 5.00mm X 5.00mm	32 LEAD 5.00mm X 5.00mm MLP Open-Pak BONDING DIAGRAM		
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETER DO NOT SCALE DRAWING	DIE PAD SIZE: 3.300mm X 3.300mm			
SEMPAC PART NO. MLP5X5-32-OP-01		THIS DOCUMENT CONTAINS INFORMATION PROPRIETARY TO SEMPAC, INC., AND REPRODUCTION OR ISSUE IN ANY FORM IS NOT PERMITTED WITHOUT AUTHORITY FROM SEMPAC, INC.		
SIZE A	PART NO. MLP5X5-32-OP-01	SCALE 32X	CAD FILE MLP5X5-32-OP-01	REV 4 SHEET 1 OF 1